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We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# International **IR** Rectifier

INSULATED GATE BIPOLAR TRANSISTOR

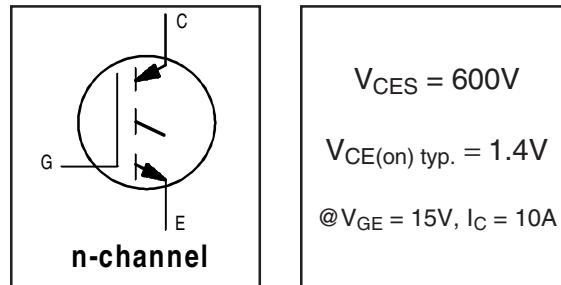
PD - 91597A

## IRG4BC20S

Standard Speed IGBT

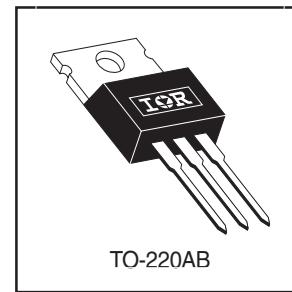
### Features

- Standard: optimized for minimum saturation voltage and low operating frequencies (< 1kHz)
- Generation 4 IGBT design provides tighter parameter distribution and higher efficiency than Generation 3
- Industry standard TO-220AB package



### Benefits

- Generation 4 IGBTs offer highest efficiency available
- IGBTs optimized for specified application conditions
- Designed to be a "drop-in" replacement for equivalent industry-standard Generation 3 IR IGBTs



### Absolute Maximum Ratings

	Parameter	Max.	Units
$V_{CES}$	Collector-to-Emitter Breakdown Voltage	600	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	19	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	10	
$I_{CM}$	Pulsed Collector Current ①	38	
$I_{LM}$	Clamped Inductive Load Current ②	38	
$V_{GE}$	Gate-to-Emitter Voltage	$\pm 20$	V
$E_{ARV}$	Reverse Voltage Avalanche Energy ③	5.0	mJ
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	60	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	24	
$T_J$ $T_{STG}$	Operating Junction and Storage Temperature Range	-55 to + 150	$^\circ C$
	Soldering Temperature, for 10 seconds	300 (0.063 in. (1.6mm) from case )	
	Mounting torque, 6-32 or M3 screw.	10 lbf•in (1.1N•m)	

### Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	2.1	$^\circ C/W$
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.50	—	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	80	
Wt	Weight	2.0 (0.07)	—	g (oz)

# IRG4BC20S

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## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

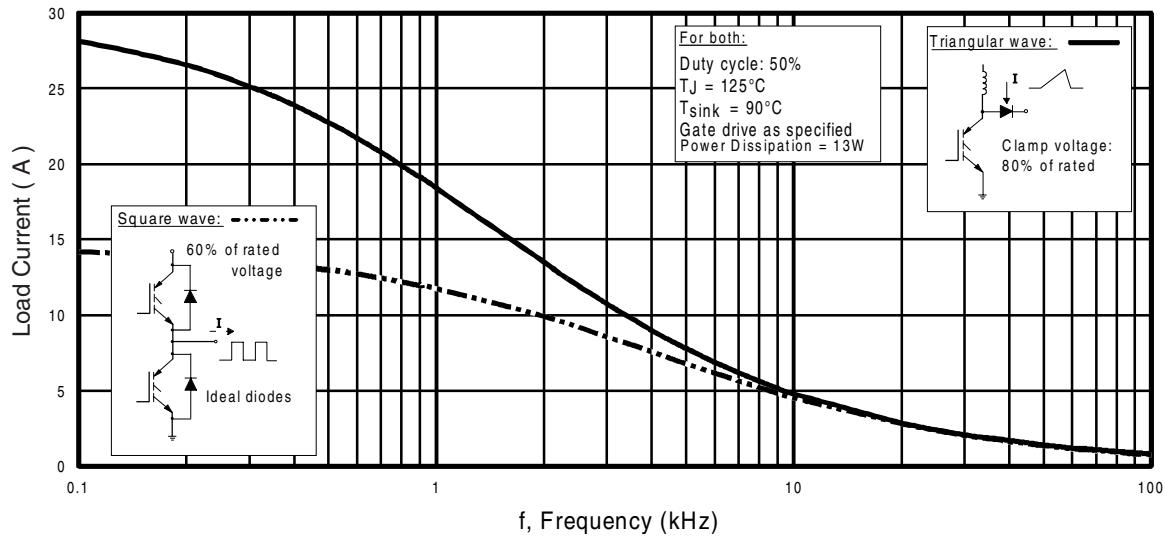
	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage	600	—	—	V	$V_{\text{GE}} = 0\text{V}, I_C = 250\mu\text{A}$
$V_{(\text{BR})\text{ECS}}$	Emitter-to-Collector Breakdown Voltage ④	18	—	—	V	$V_{\text{GE}} = 0\text{V}, I_C = 1.0\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	0.75	—	V/ $^\circ\text{C}$	$V_{\text{GE}} = 0\text{V}, I_C = 1.0\text{mA}$
$V_{\text{CE}(\text{ON})}$	Collector-to-Emitter Saturation Voltage	—	1.40	1.6	V	$I_C = 10\text{A}$ $V_{\text{GE}} = 15\text{V}$
		—	1.85	—		$I_C = 19\text{A}$ See Fig.2, 5
		—	1.44	—		$I_C = 10\text{A}, T_J = 150^\circ\text{C}$
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	3.0	—	6.0		$V_{\text{CE}} = V_{\text{GE}}, I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-11	—	mV/ $^\circ\text{C}$	$V_{\text{CE}} = V_{\text{GE}}, I_C = 250\mu\text{A}$
$g_{\text{fe}}$	Forward Transconductance ⑤	2.0	5.8	—	S	$V_{\text{CE}} = 100\text{V}, I_C = 10\text{A}$
$I_{\text{CES}}$	Zero Gate Voltage Collector Current	—	—	250	$\mu\text{A}$	$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 600\text{V}$
		—	—	2.0		$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 10\text{V}, T_J = 25^\circ\text{C}$
		—	—	1000		$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 600\text{V}, T_J = 150^\circ\text{C}$
$I_{\text{GES}}$	Gate-to-Emitter Leakage Current	—	—	$\pm 100$	nA	$V_{\text{GE}} = \pm 20\text{V}$

## Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

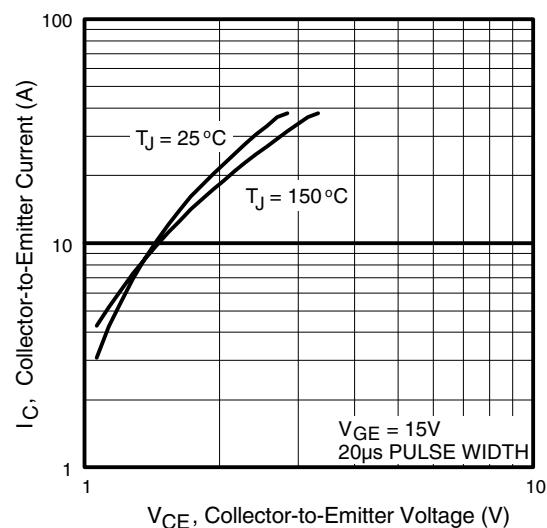
	Parameter	Min.	Typ.	Max.	Units	Conditions
$Q_g$	Total Gate Charge (turn-on)	—	27	40	nC	$I_C = 10\text{A}$
$Q_{ge}$	Gate - Emitter Charge (turn-on)	—	4.3	6.5		$V_{\text{CC}} = 400\text{V}$ See Fig. 8
$Q_{gc}$	Gate - Collector Charge (turn-on)	—	10	15		$V_{\text{GE}} = 15\text{V}$
$t_{d(\text{on})}$	Turn-On Delay Time	—	27	—	ns	$T_J = 25^\circ\text{C}$ $I_C = 10\text{A}, V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}, R_G = 50\Omega$
$t_r$	Rise Time	—	9.7	—		
$t_{d(\text{off})}$	Turn-Off Delay Time	—	540	810		
$t_f$	Fall Time	—	430	640		
$E_{\text{on}}$	Turn-On Switching Loss	—	0.12	—	mJ	Energy losses include "tail" See Fig. 9, 10, 14
$E_{\text{off}}$	Turn-Off Switching Loss	—	2.05	—		
$E_{ts}$	Total Switching Loss	—	2.17	3.2		
$t_{d(\text{on})}$	Turn-On Delay Time	—	25	—	ns	$T_J = 150^\circ\text{C},$ $I_C = 10\text{A}, V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}, R_G = 50\Omega$
$t_r$	Rise Time	—	13	—		
$t_{d(\text{off})}$	Turn-Off Delay Time	—	760	—		
$t_f$	Fall Time	—	780	—		
$E_{ts}$	Total Switching Loss	—	3.46	—	mJ	Energy losses include "tail" See Fig. 11, 14
$L_E$	Internal Emitter Inductance	—	7.5	—	nH	Measured 5mm from package
$C_{\text{ies}}$	Input Capacitance	—	550	—	pF	$V_{\text{GE}} = 0\text{V}$ $V_{\text{CC}} = 30\text{V}$ See Fig. 7 $f = 1.0\text{MHz}$
$C_{\text{oes}}$	Output Capacitance	—	39	—		
$C_{\text{res}}$	Reverse Transfer Capacitance	—	7.1	—		

### Notes:

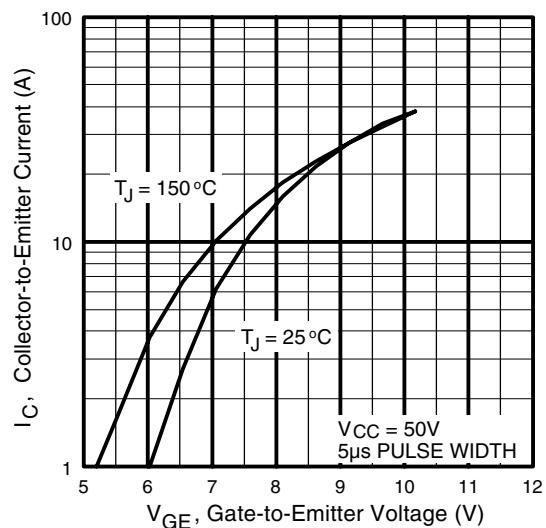
- ① Repetitive rating;  $V_{\text{GE}} = 20\text{V}$ , pulse width limited by max. junction temperature. ( See fig. 13b )
- ②  $V_{\text{CC}} = 80\%(V_{\text{CES}})$ ,  $V_{\text{GE}} = 20\text{V}$ ,  $L = 10\mu\text{H}$ ,  $R_G = 50\Omega$ , ( See fig. 13a )
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ④ Pulse width  $\leq 80\mu\text{s}$ ; duty factor  $\leq 0.1\%$ .
- ⑤ Pulse width  $5.0\mu\text{s}$ , single shot.



**Fig. 1 - Typical Load Current vs. Frequency**  
 (Load Current =  $I_{\text{RMS}}$  of fundamental)



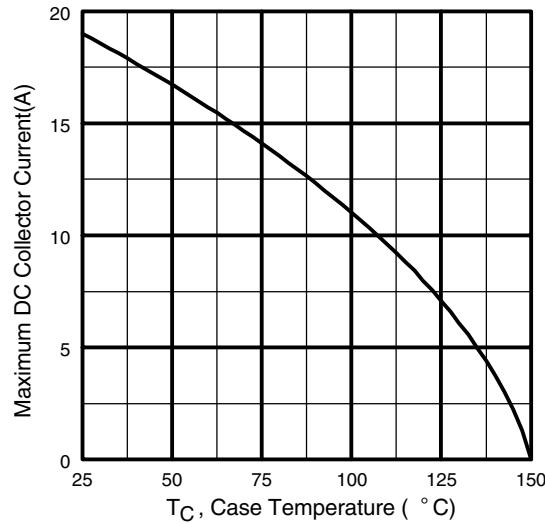
**Fig. 2 - Typical Output Characteristics**



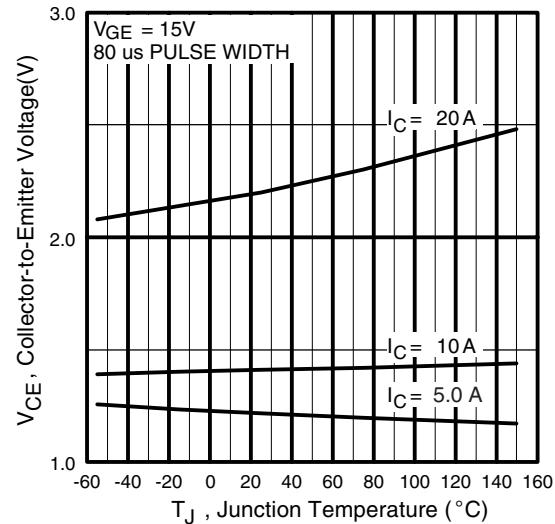
**Fig. 3 - Typical Transfer Characteristics**

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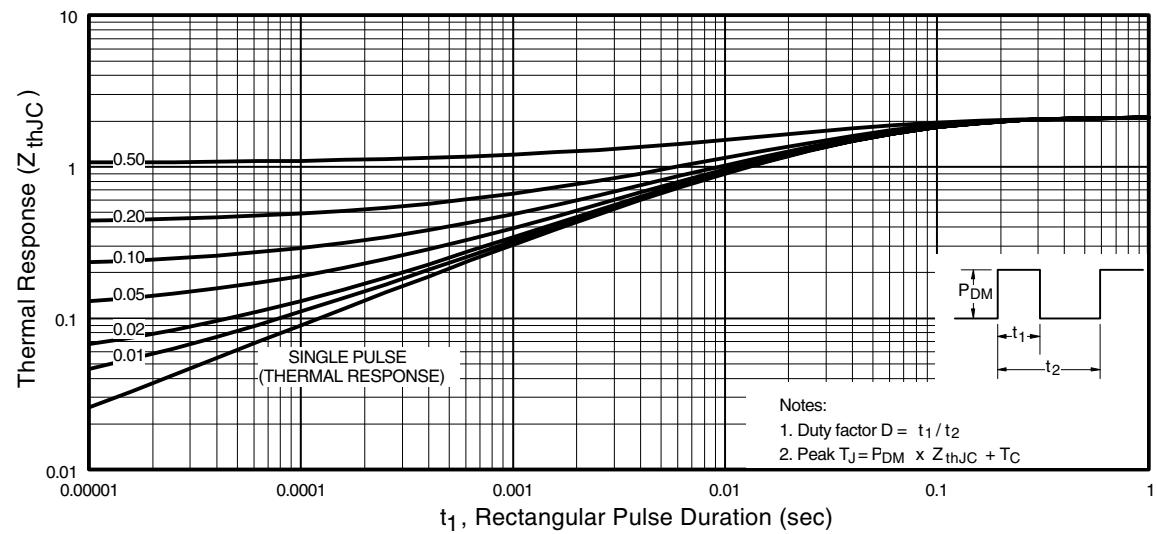
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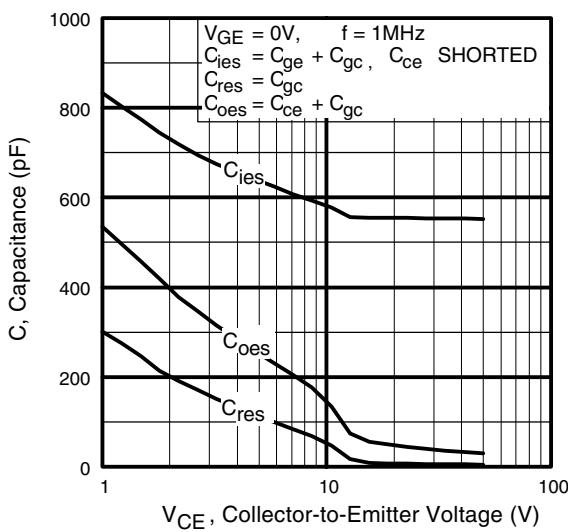
**Fig. 4 - Maximum Collector Current vs. Case Temperature**



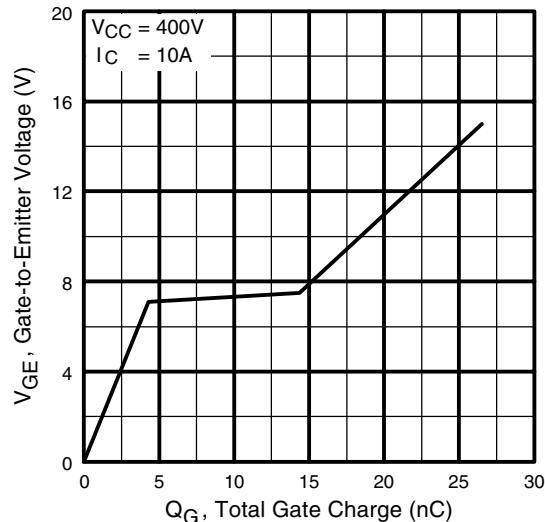
**Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature**



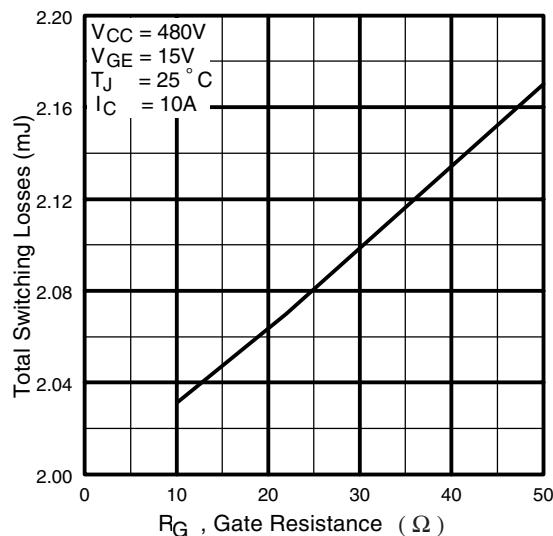
**Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case**



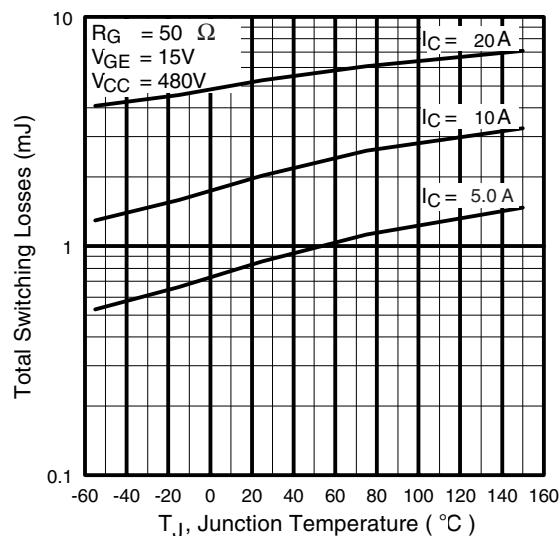
**Fig. 7 - Typical Capacitance vs.  
Collector-to-Emitter Voltage**



**Fig. 8 - Typical Gate Charge vs.  
Gate-to-Emitter Voltage**



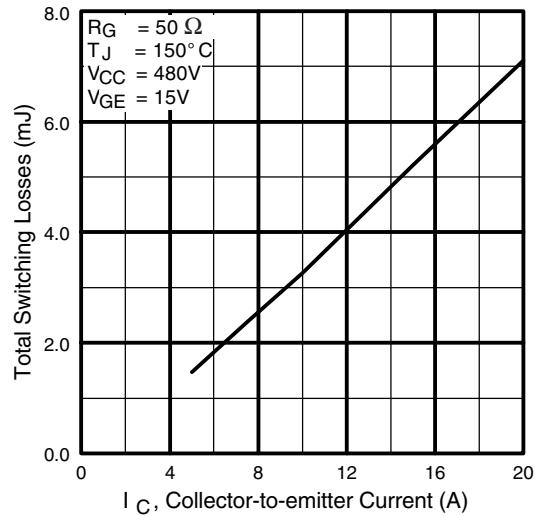
**Fig. 9 - Typical Switching Losses vs. Gate  
Resistance**



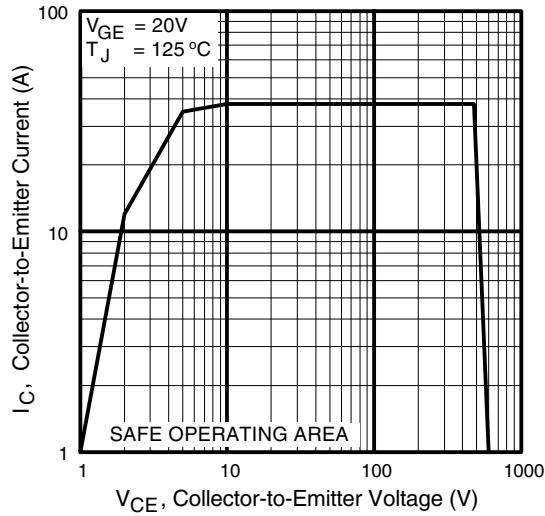
**Fig. 10 - Typical Switching Losses vs.  
Junction Temperature**

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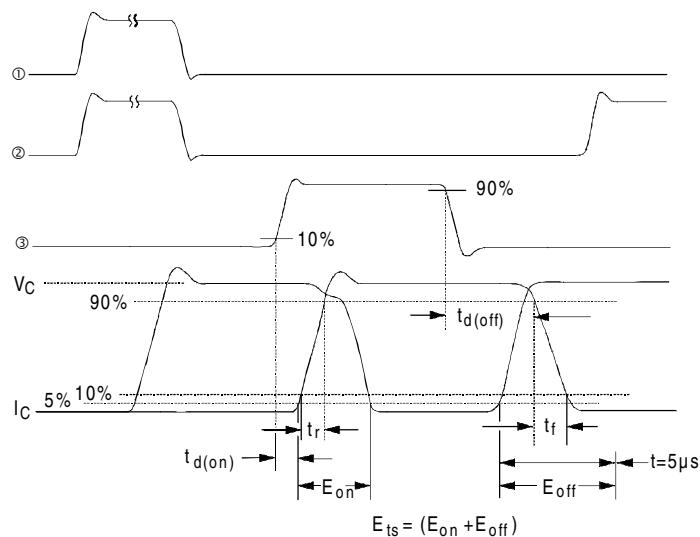
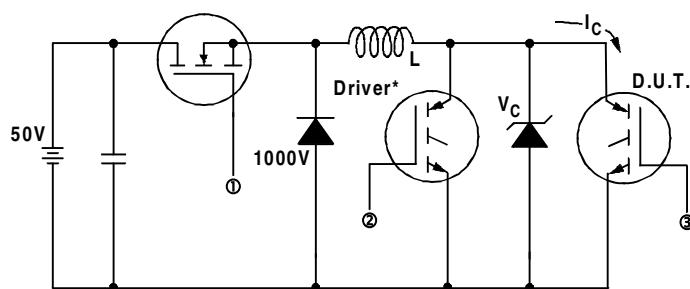
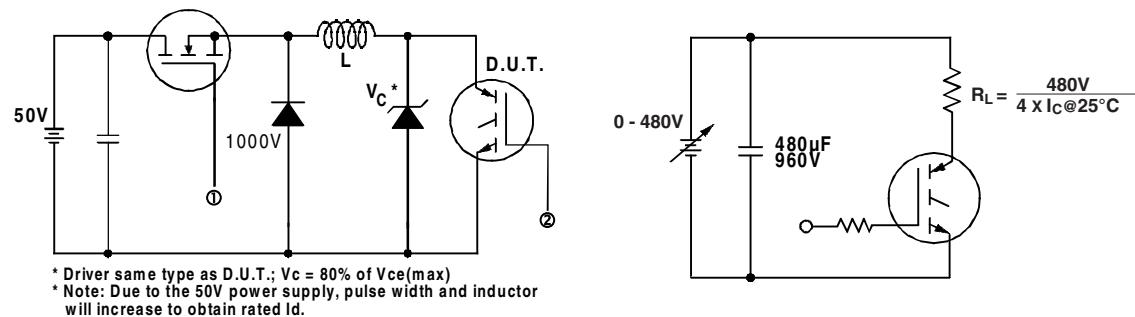
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**Fig. 11** - Typical Switching Losses vs.  
Collector-to-Emitter Current



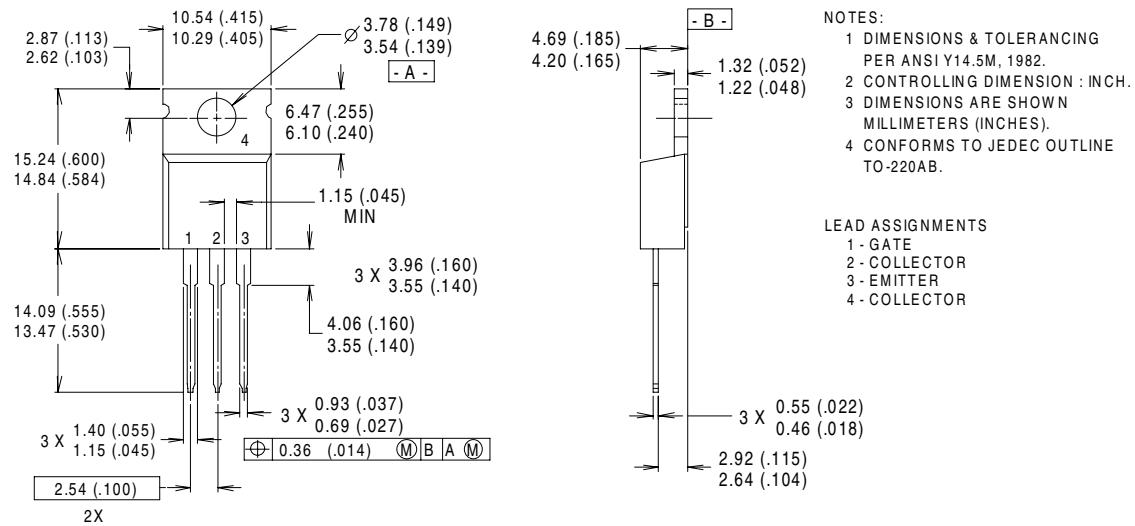
**Fig. 12** - Turn-Off SOA



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## Case Outline and Dimensions — TO-220AB



### CONFORMS TO JEDEC OUTLINE TO-220AB

Dimensions in Millimeters and (Inches)

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*Data and specifications subject to change without notice. 4/00*

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Note: For the most current drawings please refer to the IR website at:  
<http://www.irf.com/package/>